






LITE-ON Module			
	WSG300M	WSG301M	WSG303M
IC Vendor	M2COMM	M2COMM	M2COMM
Module size	19 x 13.5 mm	24 x 13.5 mm	24 x 13.5 mm
Form factor	LGA	LGA	LGA
Pin Number	21	29	34
External FEM PA			
RF IPEX connector		•	•
RF PAD	•		
MCU	M2C8001	M2C8001	M2C8001
Bluetooth BLE			
Uplink	•	•	•
Downlink			
AT command set	•	•	•
Maximum output power	14dBm	22dBm	14/22dBm
Operation Voltage	2.5V to 5.5V	2.5V to 5.5V	2.5V to 5.5V
Operation Temperature	-40 °C ~ 80 °C	-40 °C ~ 80 °C	-40 °C ~ 80 °C
EU(RCZ1)	•		•
US(RCZ2)		•	•
JP(RCZ3)			•
Asia(RCZ4)		•	•